



US00D575242S

(12) **United States Design Patent**
Otsuki et al.

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(45) **Date of Patent:** **** Aug. 19, 2008**

(54) **FAN**

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(73) Assignee: **Nidec Corporation**, Kyoto (JP)

Translation of the official communication issued in the counterpart Japanese Application No. 2006-008877, mailed on Oct. 13, 2006.

(**) Term: **14 Years**

(Continued)

(21) Appl. No.: **29/249,373**

Primary Examiner—Selina Sikder

(74) *Attorney, Agent, or Firm*—Keating & Bennett, LLP

(22) Filed: **Oct. 4, 2006**

(57) **CLAIM**

(30) **Foreign Application Priority Data**

The ornamental design for a fan, as shown and described.

Apr. 5, 2006 (JP) 2006-008877

DESCRIPTION

(51) **LOC (8) Cl.** **13-03**

(52) **U.S. Cl.** **D13/179**

(58) **Field of Classification Search** D13/179;
165/80.3, 104.33, 151, 122, 185; 257/706,
257/707, 718–722; 361/687, 695, 697, 700,
361/702, 704, 709, 710, 711, 719
See application file for complete search history.

FIG. 1 is a bottom plan view of a fan showing our new design;

FIG. 2 is a top plan view thereof;

FIG. 3 is a left side elevation view thereof;

FIG. 4 is a right side elevation view thereof;

FIG. 5 is a front elevation view thereof;

FIG. 6 is a rear elevation view thereof;

FIG. 7 is a perspective view thereof;

FIG. 8 is a reference bottom plan view

FIG. 9 is a reference top plan view thereof;

FIG. 10 is a reference left side elevation view thereof;

FIG. 11 is a reference right side elevation view thereof;

FIG. 12 is a reference front elevation view thereof;

FIG. 13 is a reference rear elevation view thereof; and,

FIG. 14 is a reference perspective view thereof.

The lead wires are shown broken away in FIGS. 3–6 to indicate indeterminate length, it being understood that the wires have uniform shape and appearance through their length.

The broken lines in FIGS. 8–14 represent unclaimed subject matter.

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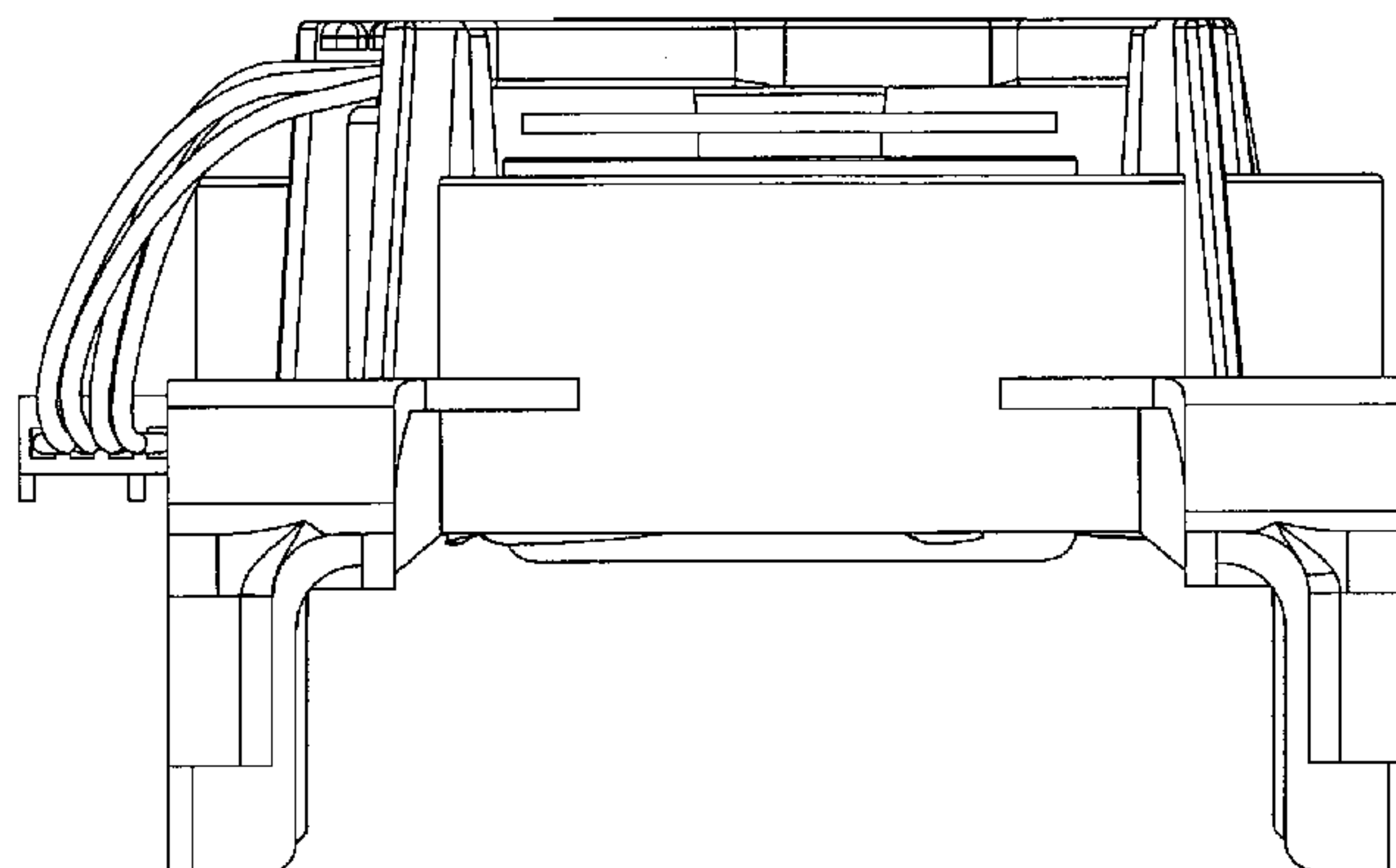
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1 Claim, 14 Drawing Sheets



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Fig.1

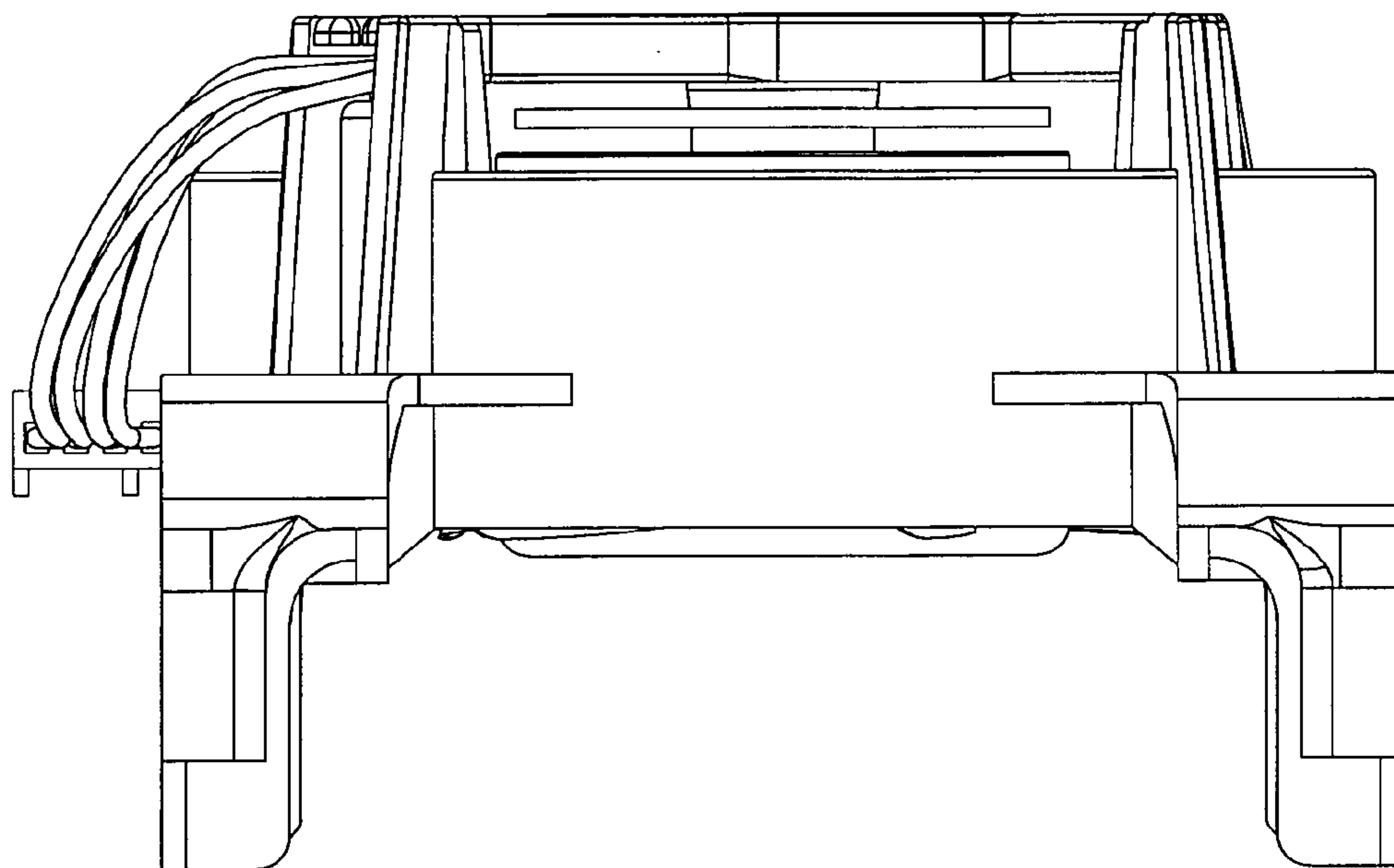


Fig. 2

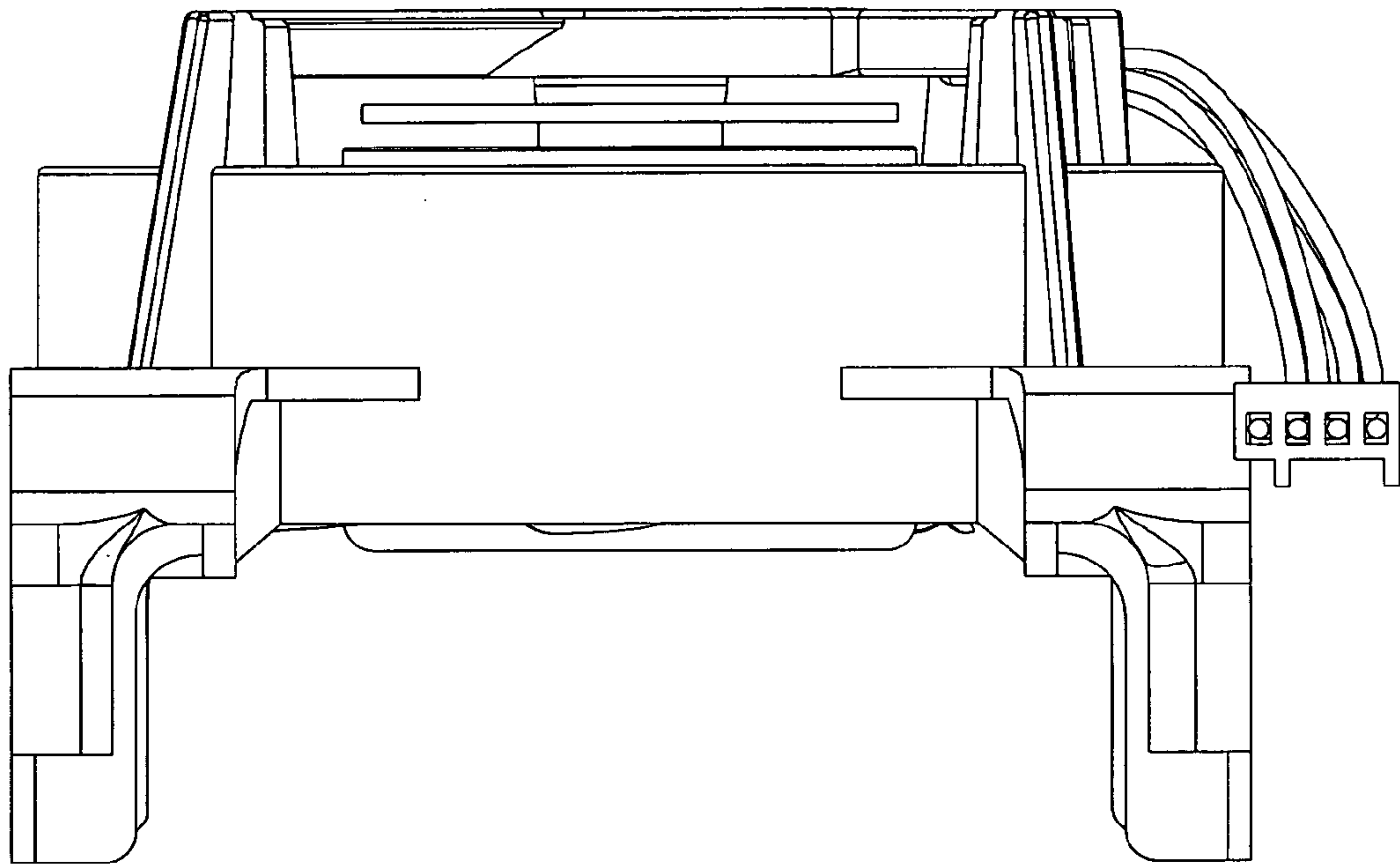


Fig. 3

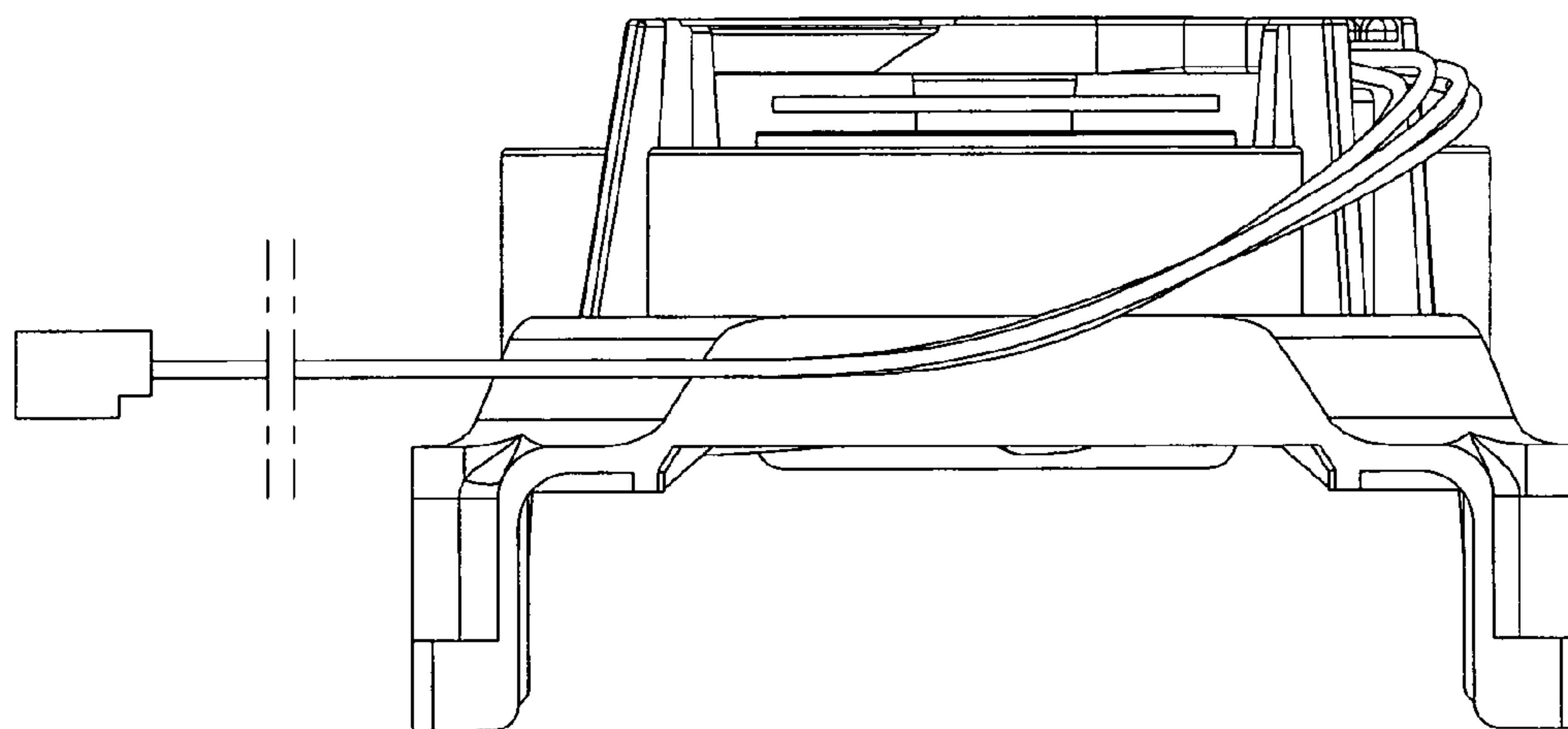


Fig. 4

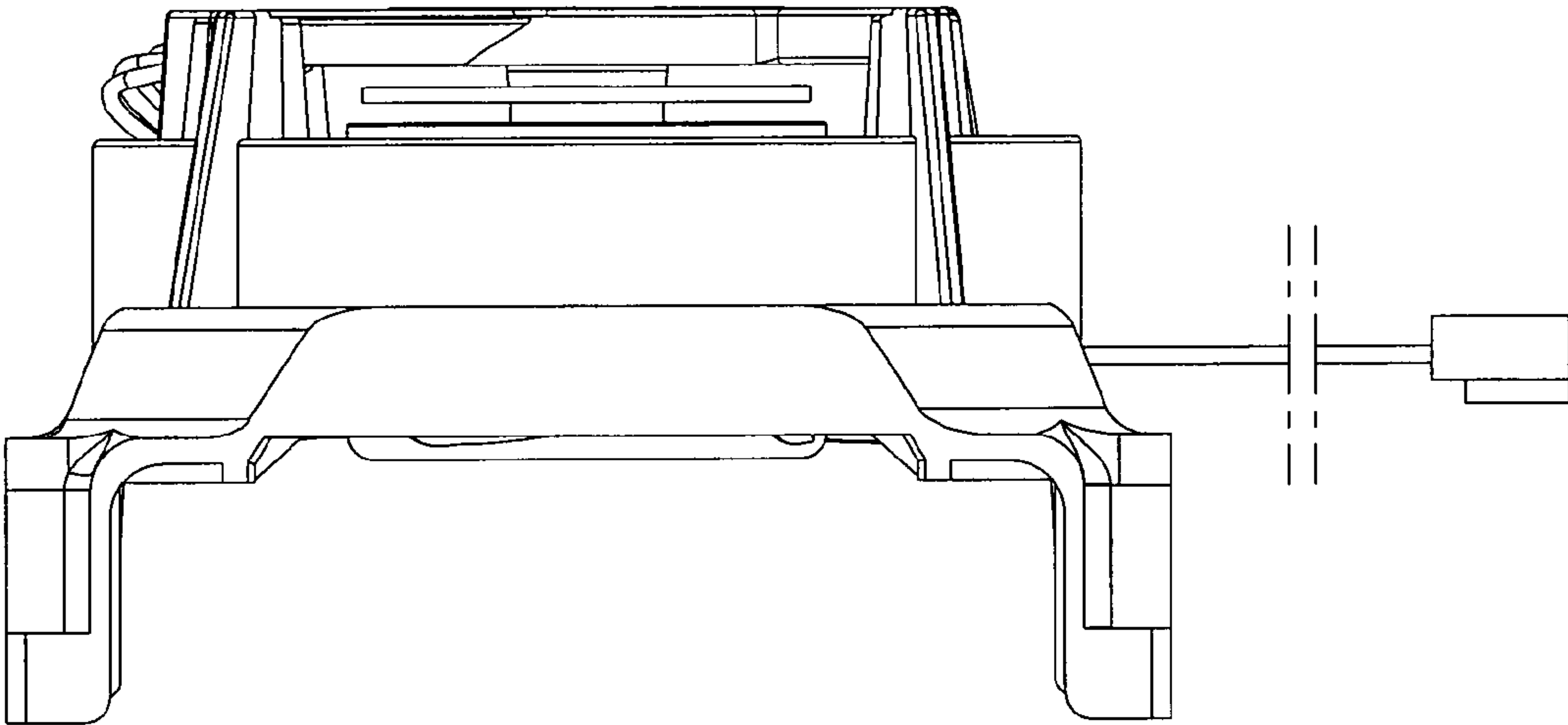


Fig. 5

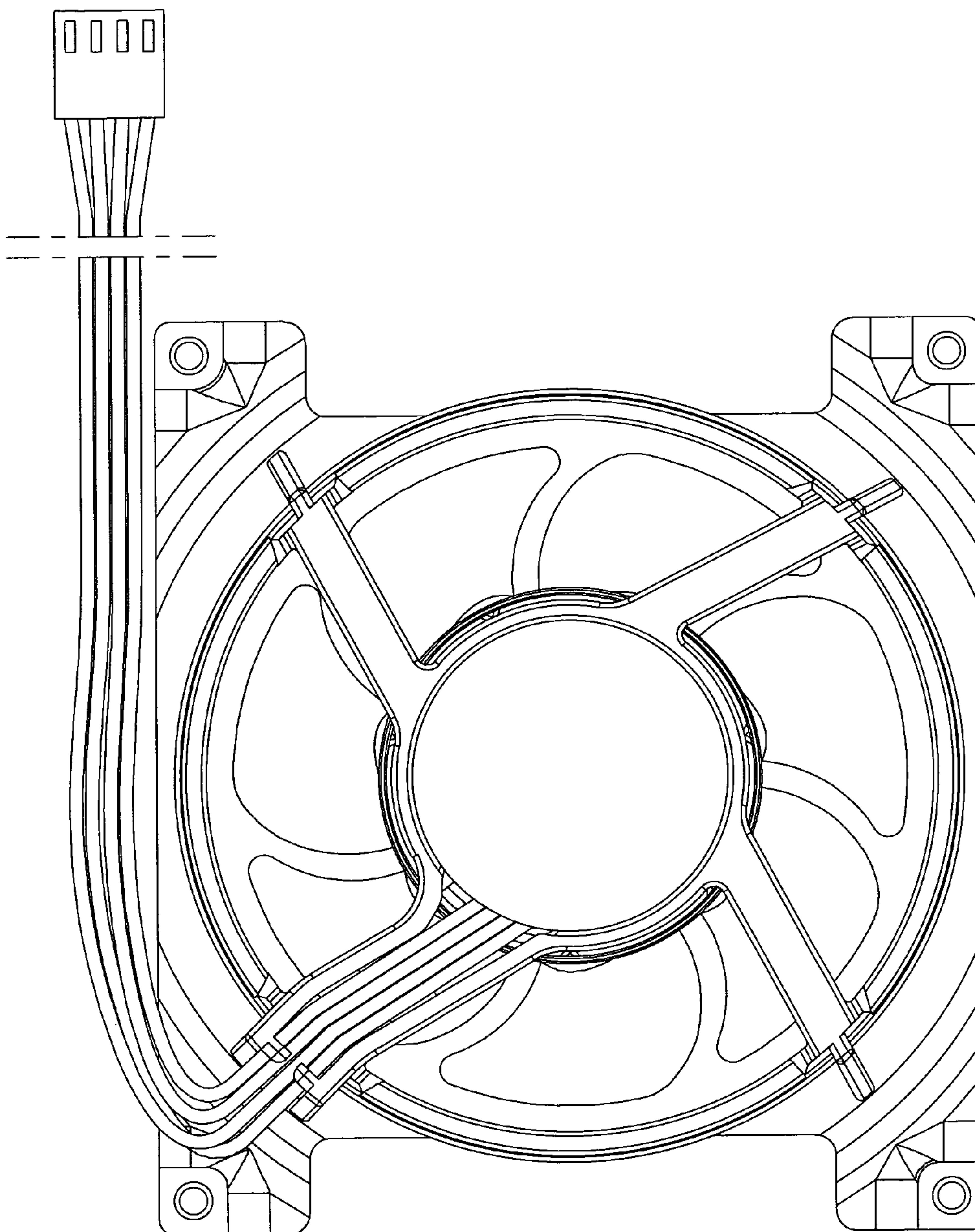


Fig. 6

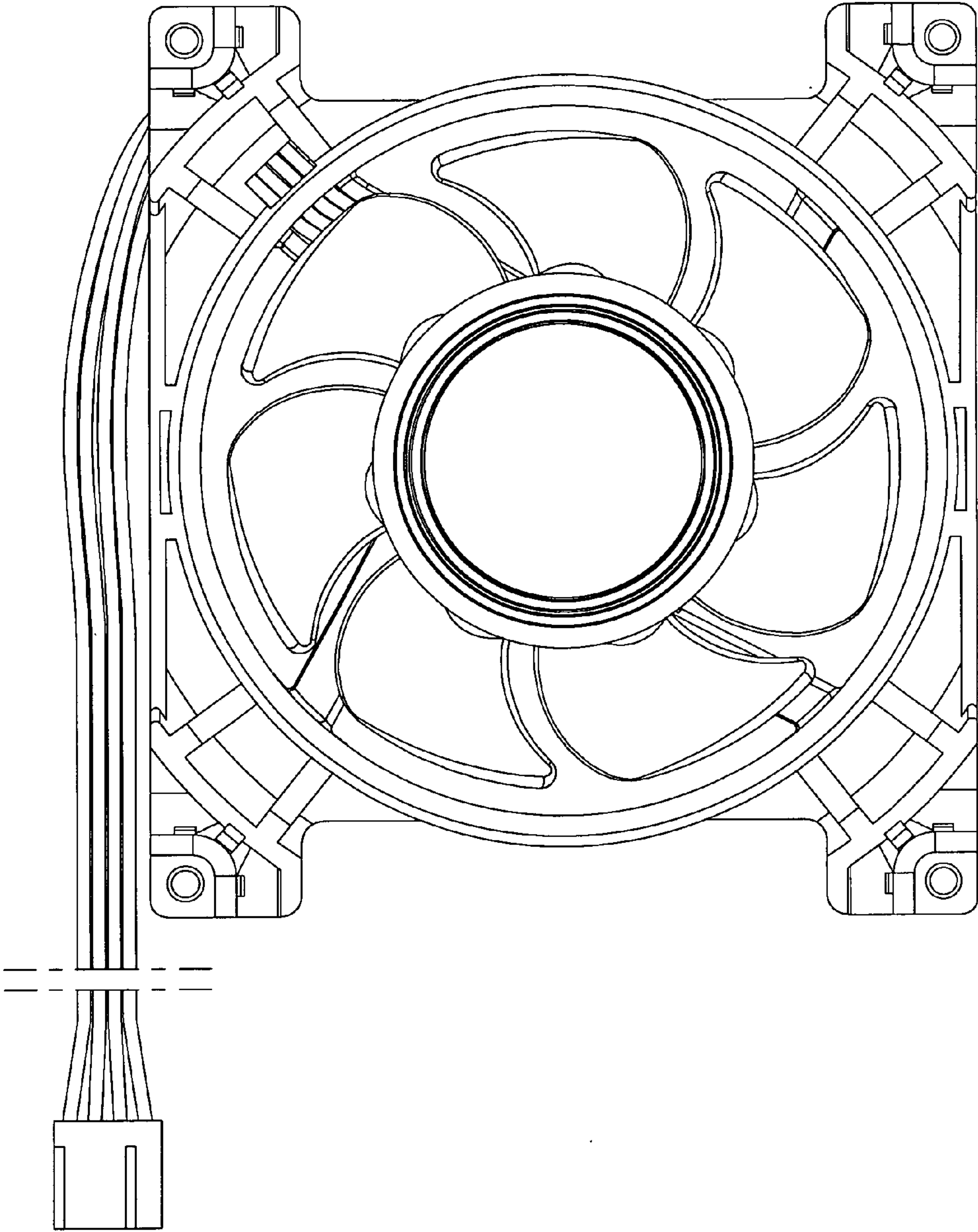


Fig. 7

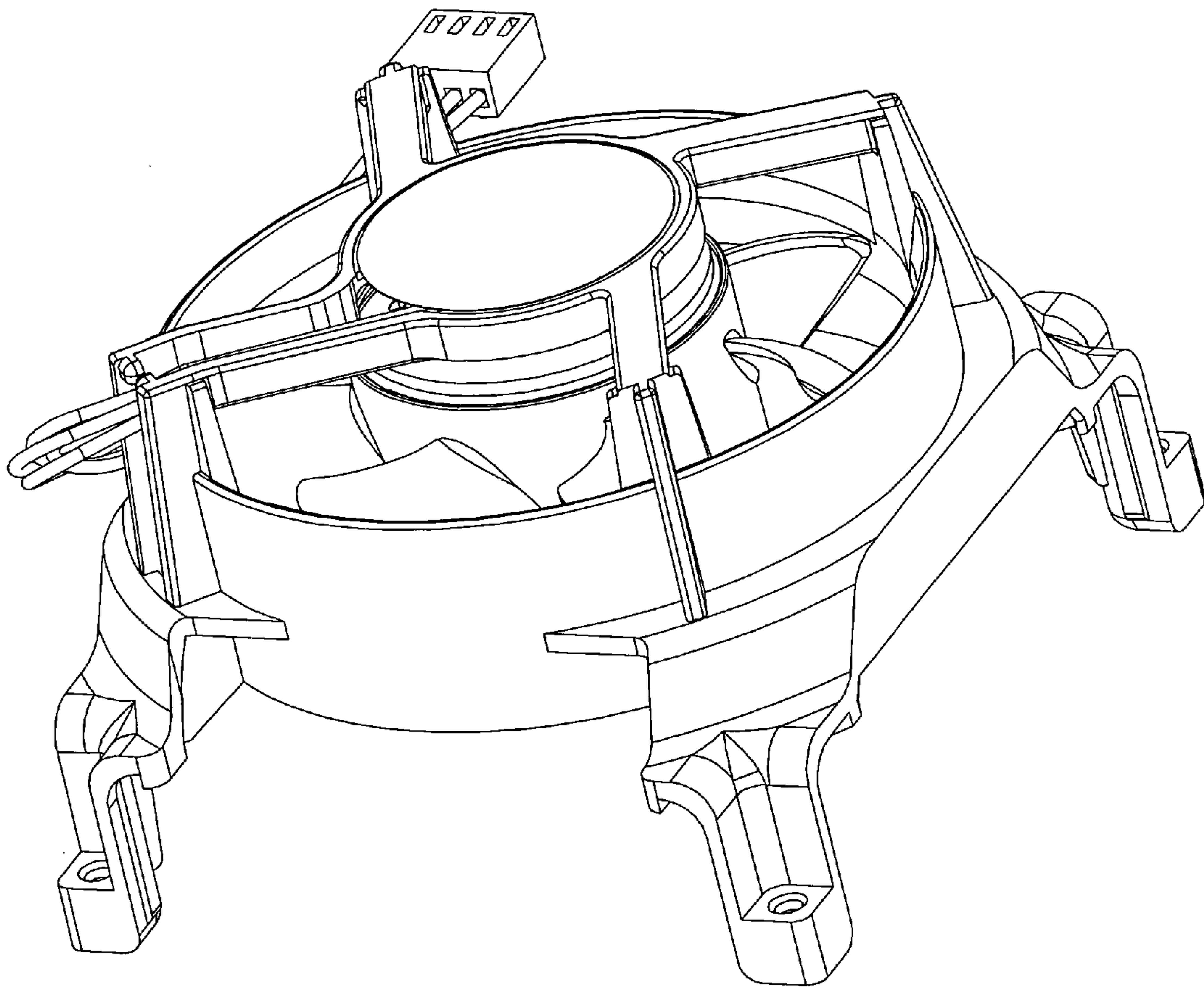


Fig. 8

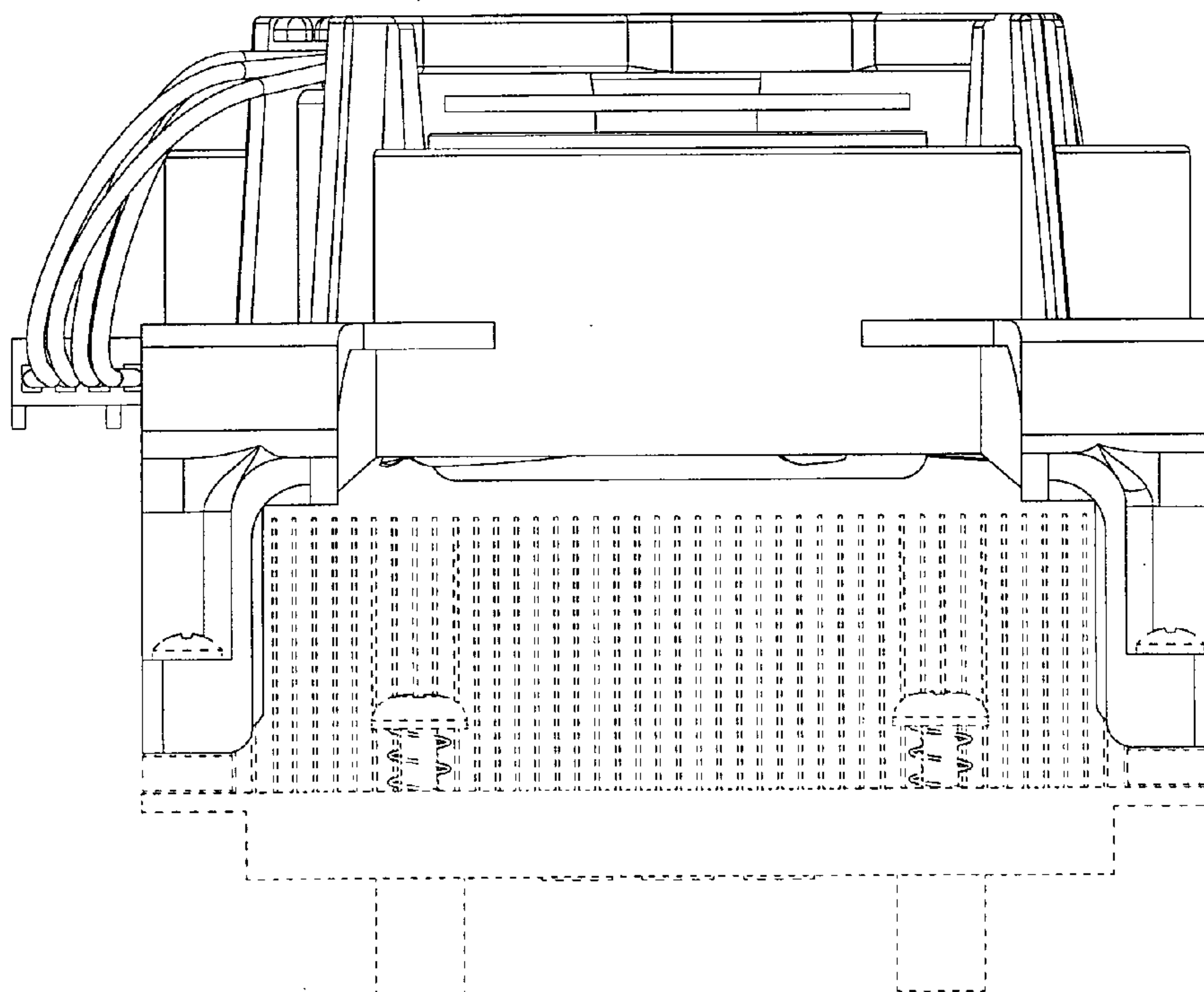


Fig. 9

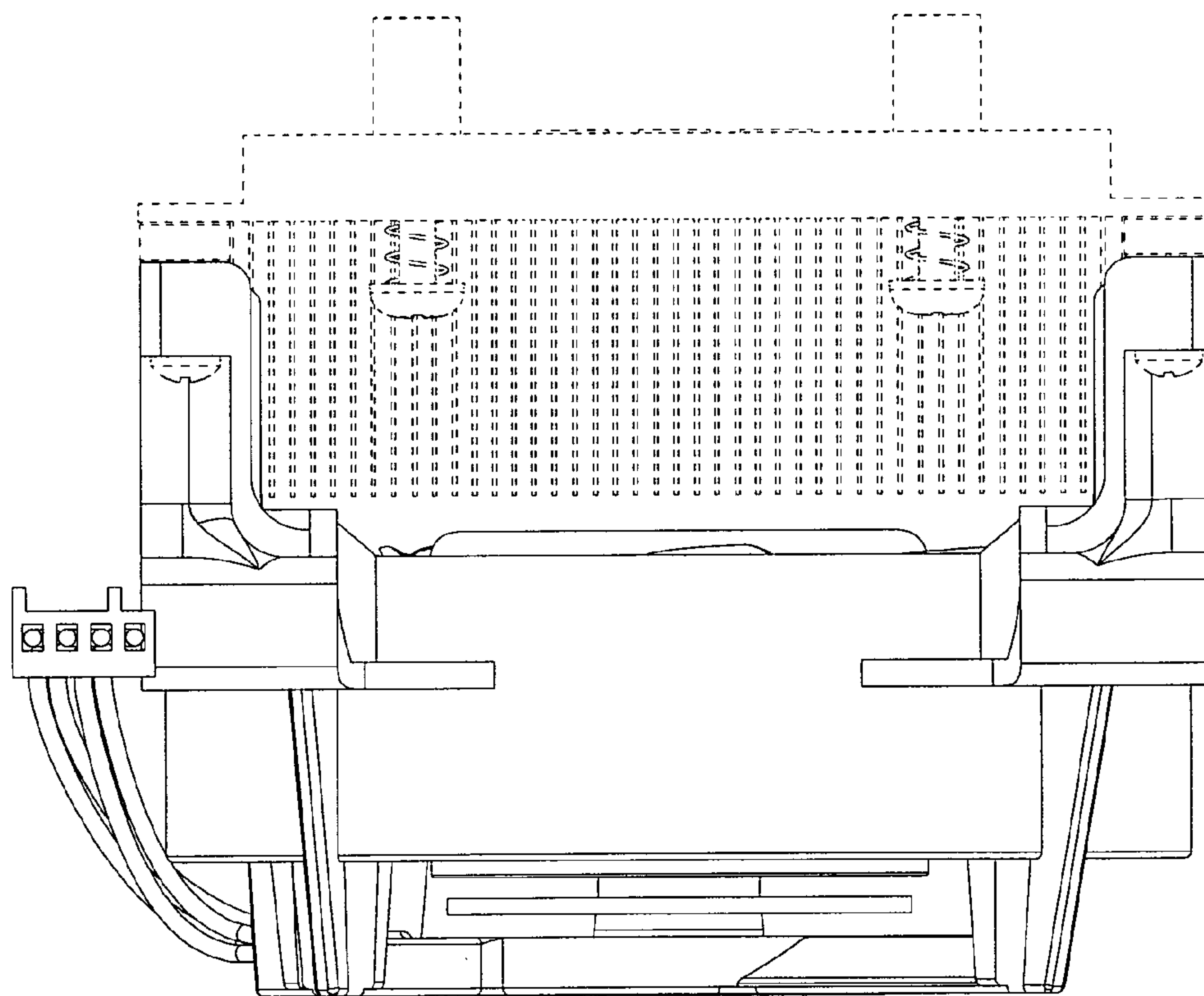


Fig. 10

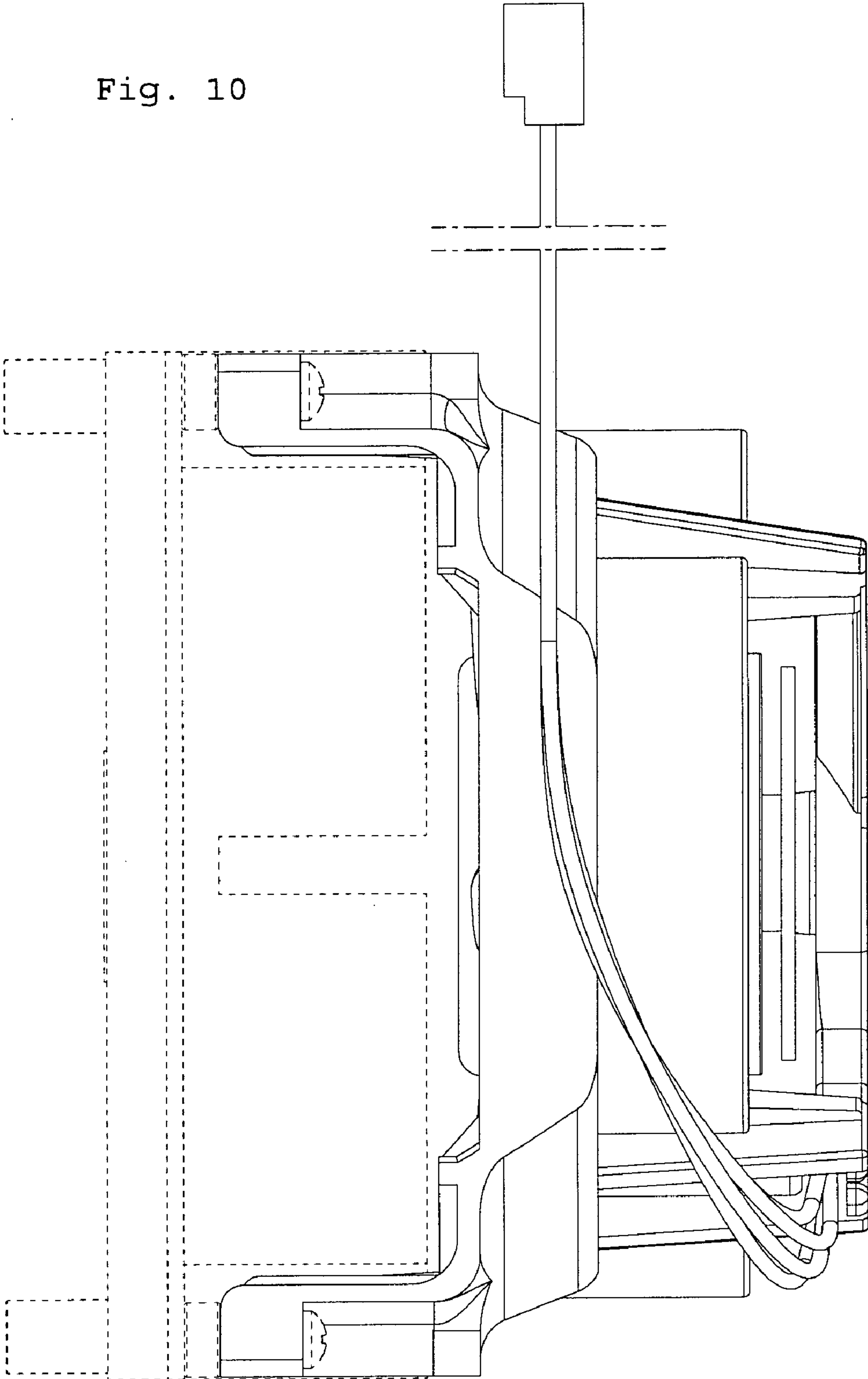
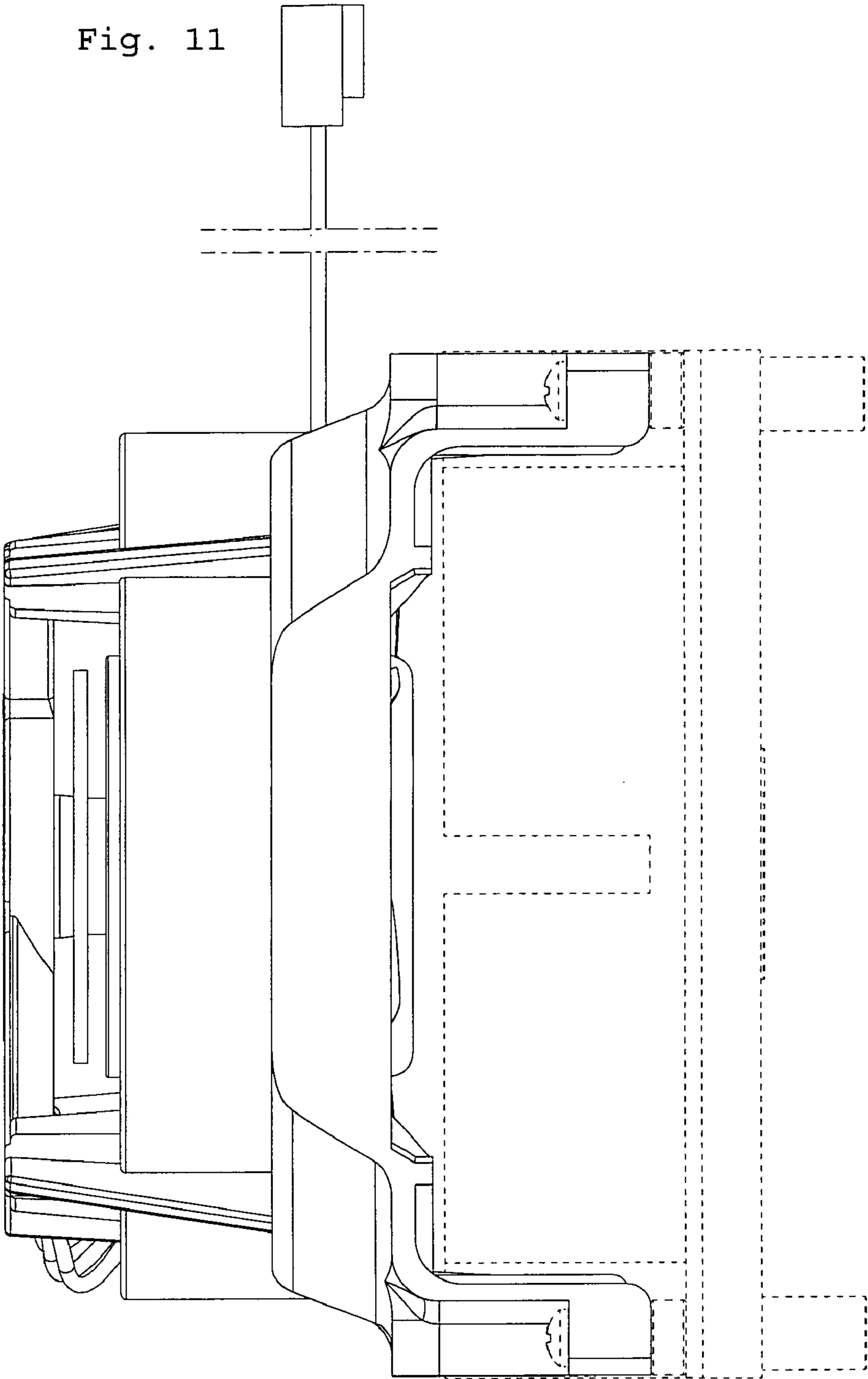


Fig. 11



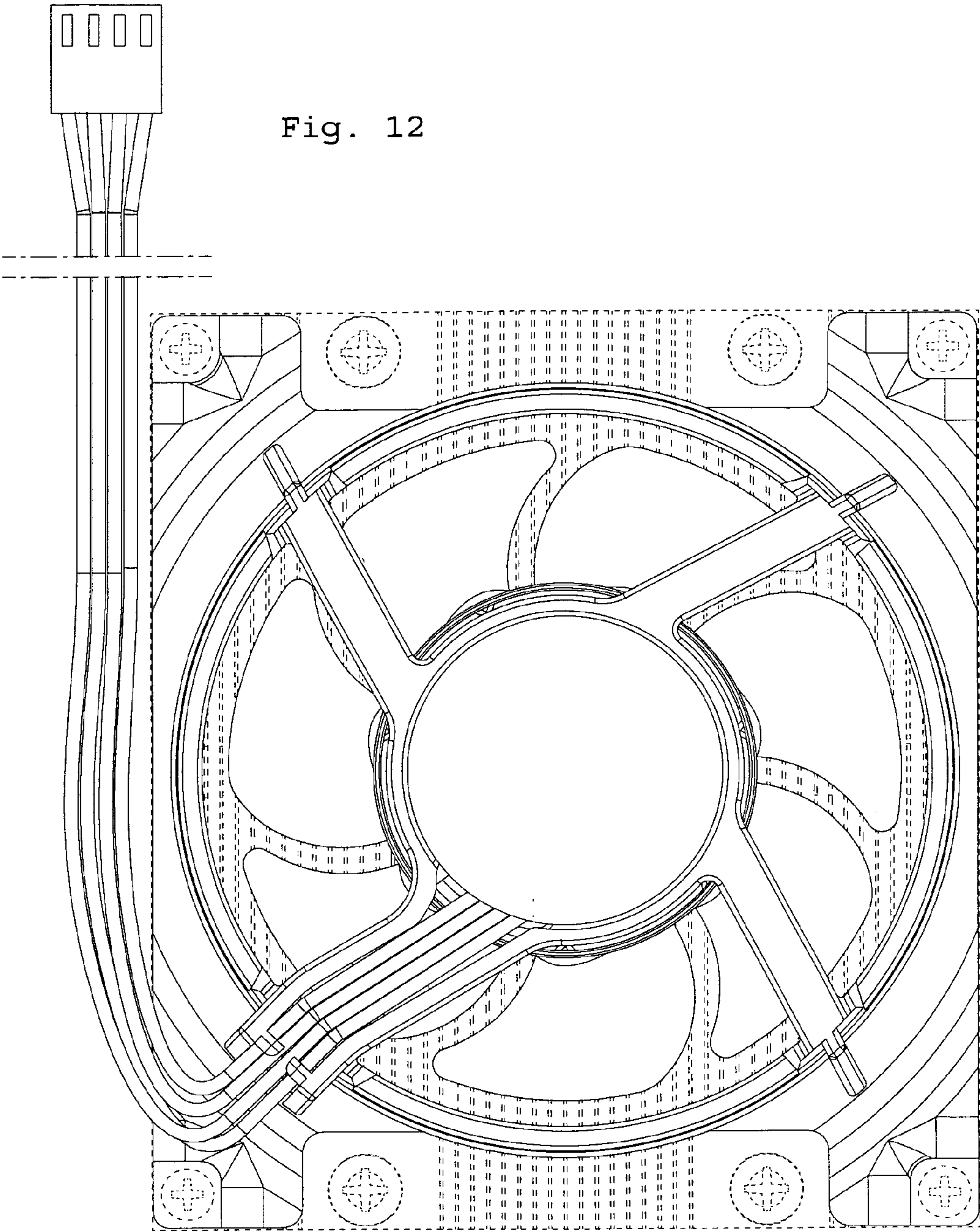


Fig. 13

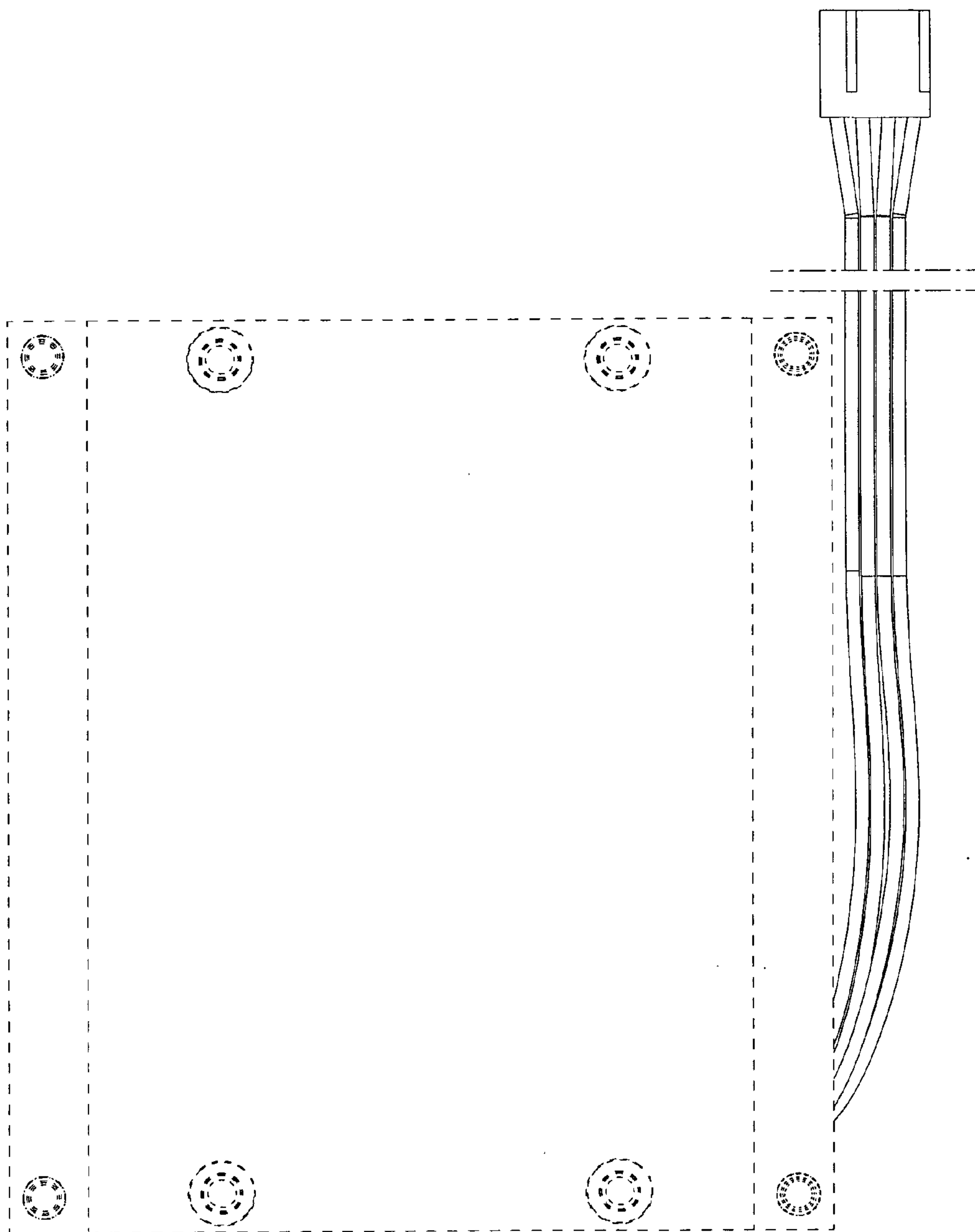


Fig. 14

